## Flash-e\_n8Gs16M\_Rev\_C-BOM

Quantity	Designation	Package	Designator
3	22R/R0402	R0402	R4,R7,R8
			R1,R2,R3,
6	10k/R0402	R0402	R14,R16,R17
4	100nF/10V/10%/X7R/C0402	C0402	C1,C2,C3,C11
	MT29F64G08CBABA-WP:B		
1	(TSOP48)	TSOP48	U1
1	W25Q128JVSIQ(SOIC-8_208mils)	SO-8_208mil	U3
1	DF12(3.5)-40DP-0.5V(86)	DF12(3.5)-40DP-0.5V(86) (CL0537-0032-4-86)	Flash_CON1
2	Opened	SJ_1_SMALLER	NAND_WP1, SPI_WP1
2	NA(22R/R0402)	R0402	R11,R10
4	NA(10k/R0402)	R0402	R5,R9,R12,R13
1	NA/R0402	R0402	R6
3	NA(100nF/10V/10%/X7R/C0402)	C0402	C6,C7,C9
4	NA(2.2uF/6.3V/10%/X5R/C0603)	C0603	C4,C5,C8,C10
2	NA/C0402	C0402	C12,C13
		FBGA153_Pitch-0.5mm_	
	NA(KLMAG1JETD-B041003	Ball-0.25mm_Dimensions-	
1	(FBGA153))	11.50x13.00x0.80mm	U2